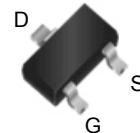


## **WPM2093**

**Single P-Channel, -20V, -0.8A, Power MOSFET**

[Http://www.sh-willsemi.com](http://www.sh-willsemi.com)

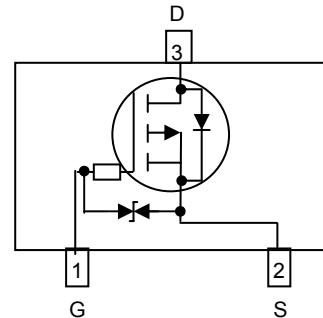
<b>V<sub>DS</sub> (V)</b>	<b>Typical R<sub>DS(on)</sub> (mΩ)</b>
<b>-20</b>	220 @ V <sub>GS</sub> =-4.5V
	280 @ V <sub>GS</sub> =-2.8V
	335 @ V <sub>GS</sub> =-2.5V
	500 @ V <sub>GS</sub> =-1.8V



**SOT-723**

### **Descriptions**

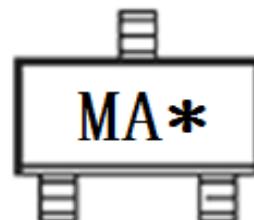
The WPM2093 is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WPM2093 is Pb-free.



**Pin configuration (Top view)**

### **Features**

- Trench Technology
- Supper high density cell design
- Excellent ON resistance
- Extremely Low Threshold Voltage
- Small package SOT-723



MA= Device Code

\*= Month(A-Z)

Marking

### **Applications**

### **Order information**

- DC/DC converters
- Power supply converters circuit
- Load/Power Switching for portable device

<b>Device</b>	<b>Package</b>	<b>Shipping</b>
WPM2093-3/TR	SOT-723	8000/Tape&Reel

## Absolute Maximum ratings

Parameter	Symbol	10 s	Steady State	Unit
Drain-Source Voltage	V <sub>DS</sub>		-20	V
Gate-Source Voltage	V <sub>GS</sub>		±10	
Continuous Drain Current <sup>a d</sup>	I <sub>D</sub>	T <sub>A</sub> =25°C T <sub>A</sub> =70°C	-0.82 -0.66	A
			-0.75 -0.60	
Maximum Power Dissipation <sup>a d</sup>	P <sub>D</sub>	T <sub>A</sub> =25°C T <sub>A</sub> =70°C	0.37 0.23	W
			0.30 0.19	
Continuous Drain Current <sup>b d</sup>	I <sub>D</sub>	T <sub>A</sub> =25°C T <sub>A</sub> =70°C	-0.70 -0.56	A
			-0.91 -0.73	
Maximum Power Dissipation <sup>b d</sup>	P <sub>D</sub>	T <sub>A</sub> =25°C T <sub>A</sub> =70°C	0.26 0.17	W
			0.45 0.28	
Pulsed Drain Current <sup>c</sup>	I <sub>DM</sub>		-1.5	A
Operating Junction Temperature	T <sub>J</sub>		-55 to 150	°C
Lead Temperature	T <sub>L</sub>		260	°C
Storage Temperature Range	T <sub>stg</sub>		-55 to 150	°C

## Thermal resistance ratings

Single Operation					
Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance <sup>a</sup>	t ≤ 10 s	R <sub>θJA</sub>	280	340	°C/W
	Steady State		345	410	
Junction-to-Ambient Thermal Resistance <sup>b</sup>	t ≤ 10 s	R <sub>θJA</sub>	400	470	°C/W
	Steady State		245	280	
Junction-to-Case Thermal Resistance	Steady State	R <sub>θJC</sub>	280	340	

a Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper

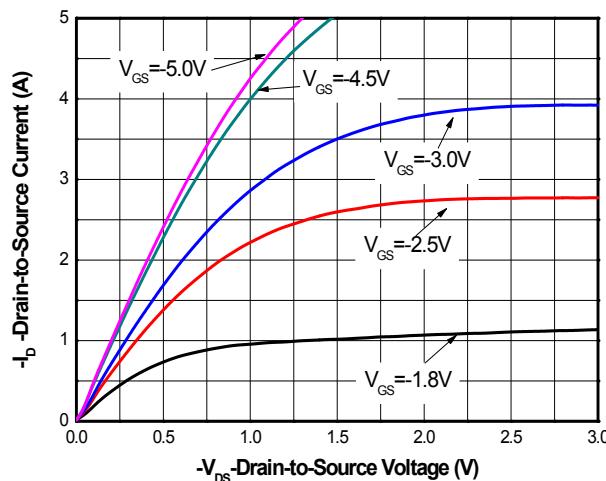
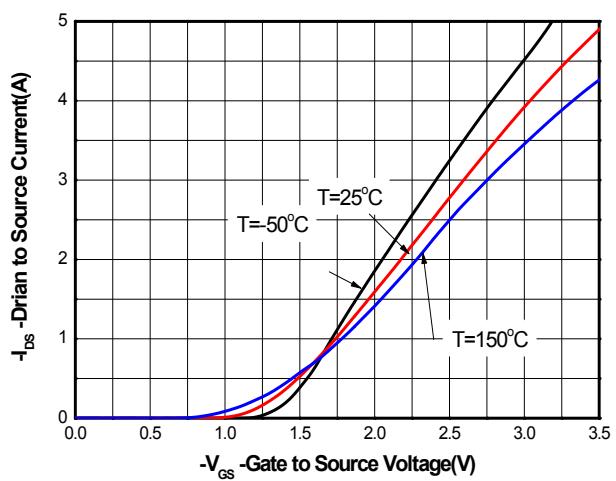
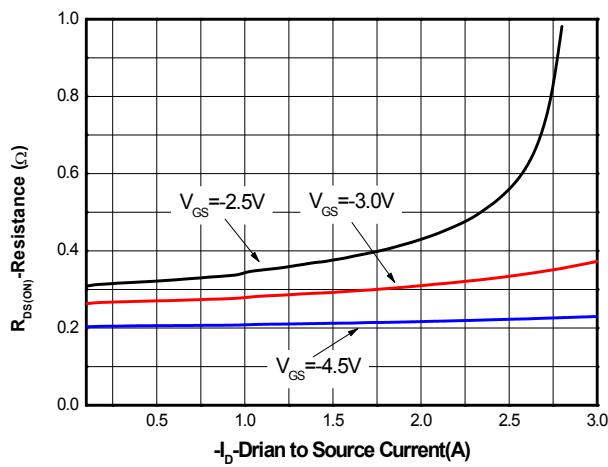
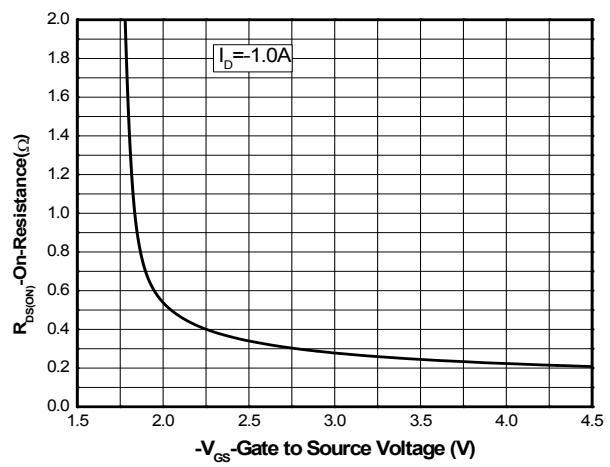
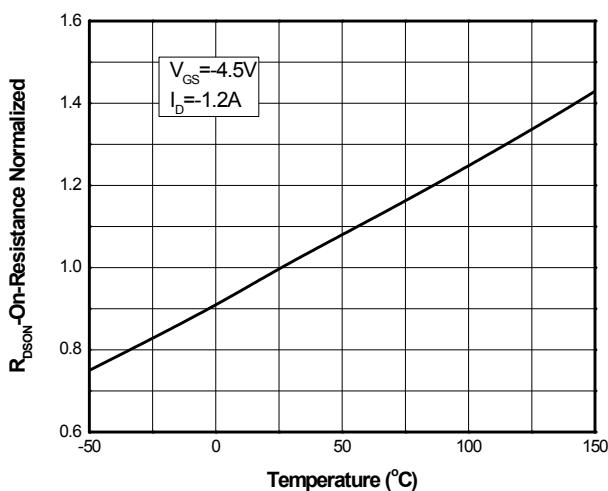
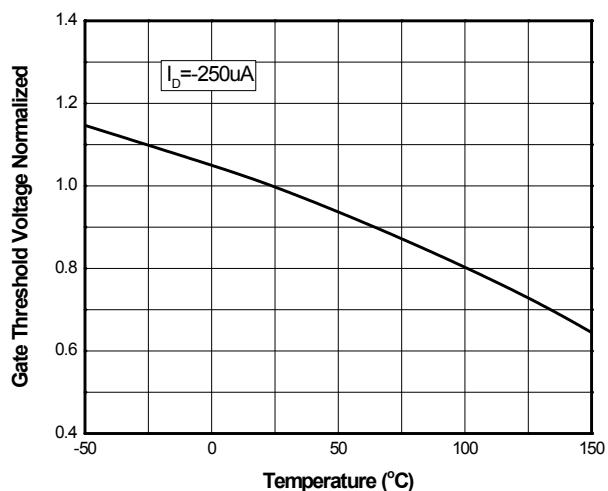
b Surface mounted on FR4 board using minimum pad size, 1oz copper

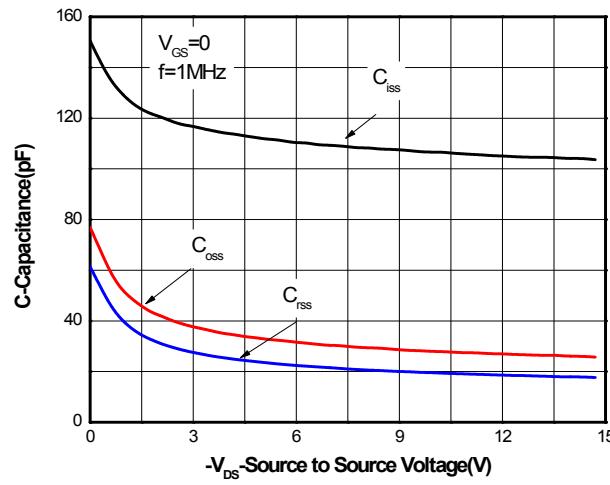
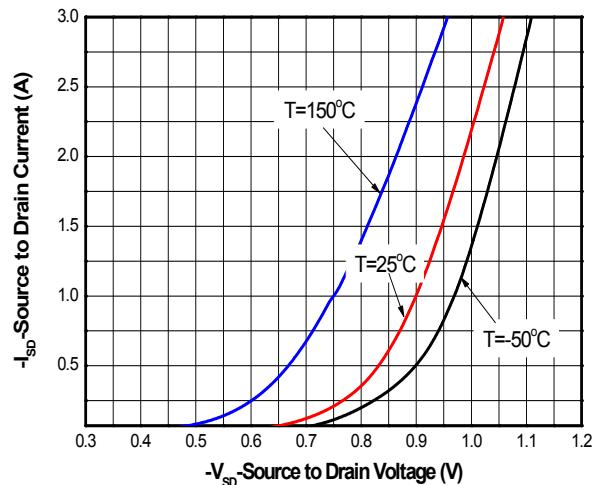
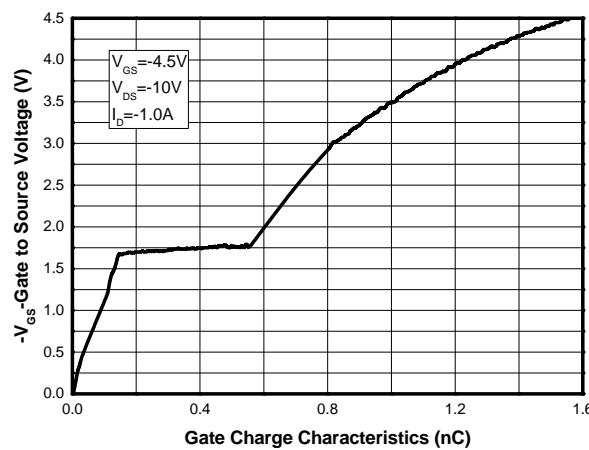
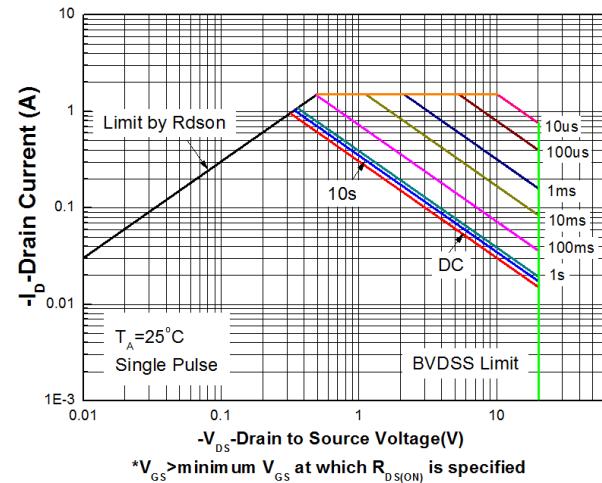
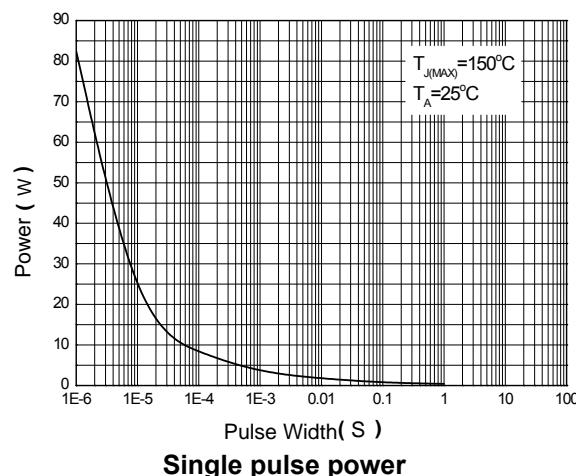
c Repetitive rating, pulse width limited by junction temperature, t<sub>p</sub>=10µs, Duty Cycle=1%

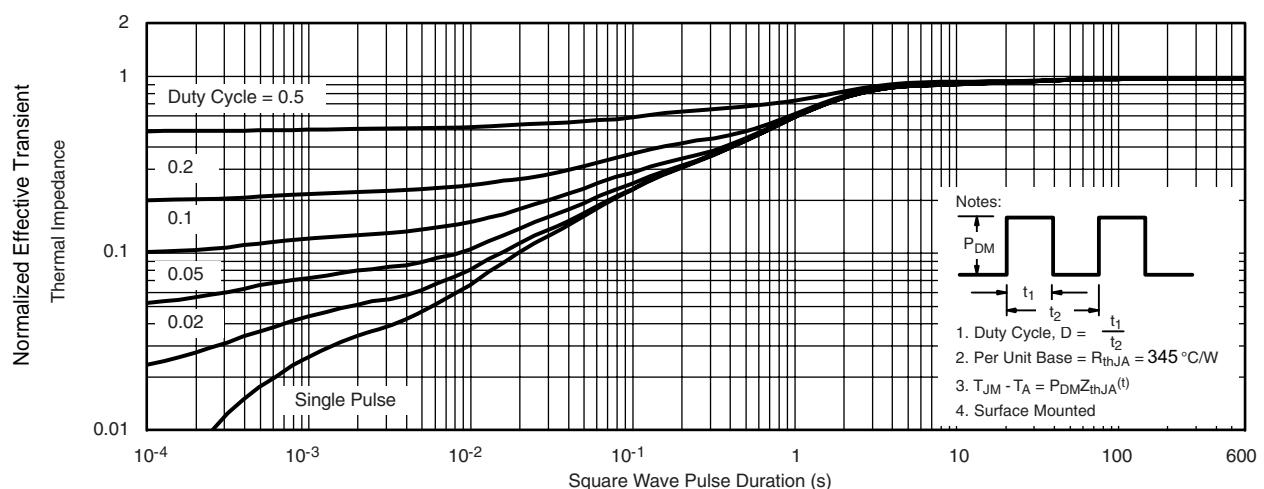
d Repetitive rating, pulse width limited by junction temperature T<sub>J</sub>=150°C.

**Electronics Characteristics (Ta=25°C, unless otherwise noted)**

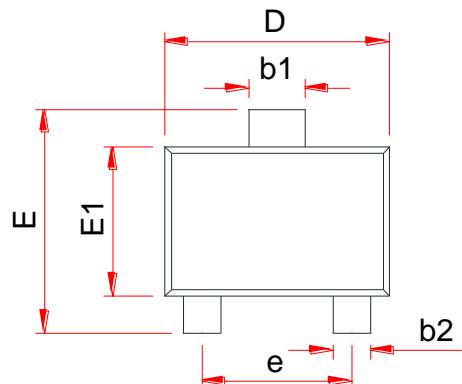
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0 \text{ V}, I_D = -250\mu\text{A}$	-20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -20\text{V}, V_{GS} = 0\text{V}$			-1	$\mu\text{A}$
Gate-to-source Leakage Current	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10\text{V}$			$\pm 5.0$	$\mu\text{A}$
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$	-0.45	0.7	-1.0	V
Drain-to-source On-resistance	$R_{DS(\text{on})}$	$V_{GS} = -4.5\text{V}, I_D = -0.8\text{A}$		220	360	$\text{m}\Omega$
		$V_{GS} = -2.8\text{V}, I_D = -0.5\text{A}$		280	400	
		$V_{GS} = -2.5\text{V}, I_D = -0.5\text{A}$		335	450	
		$V_{GS} = -1.8\text{V}, I_D = -0.3\text{A}$		500	760	
<b>CHARGES, CAPACITANCES AND GATE RESISTANCE</b>						
Input Capacitance	$C_{ISS}$	$V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}, V_{DS} = -15 \text{ V}$		104		$\text{pF}$
Output Capacitance	$C_{OSS}$			25		
Reverse Transfer Capacitance	$C_{RSS}$			19		
Total Gate Charge	$Q_{G(\text{TOT})}$	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V}, I_D = -1\text{A}$		1.10		$\text{nC}$
Threshold Gate Charge	$Q_{G(\text{TH})}$			0.25		
Gate-to-Source Charge	$Q_{GS}$			0.38		
Gate-to-Drain Charge	$Q_{GD}$			0.47		
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$td(\text{ON})$	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V}, R_G = 6 \Omega, I_D = -1\text{A}$		7.2		$\text{ns}$
Rise Time	$tr$			7.5		
Turn-Off Delay Time	$td(\text{OFF})$			18.5		
Fall Time	$tf$			10.7		
<b>BODY DIODE CHARACTERISTICS</b>						
Forward Voltage	$V_{SD}$	$V_{GS} = 0 \text{ V}, I_S = -0.5\text{A}$	-0.5	-0.8	-1.2	V

**Typical Characteristics (Ta=25°C, unless otherwise noted)**

**Output characteristics**

**Transfer characteristics**

**On-Resistance vs. Drain current**

**On-Resistance vs. Gate-to-source voltage**

**On-Resistance vs. Junction temperature**

**Threshold voltage vs. Temperature**

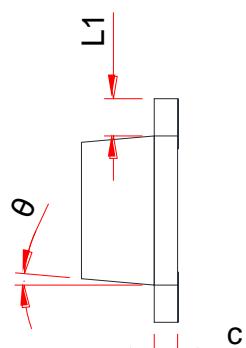
**Capacitance****Body diode forward voltage****Gate Charge Characteristics****Safe operating power****Single pulse power**



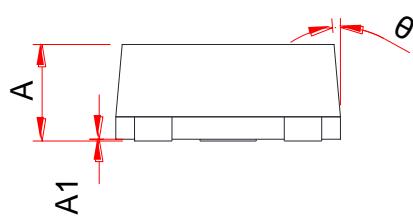
**Transient thermal response (Junction-to-Ambient)**

**Package outline dimensions**
**SOT-723**


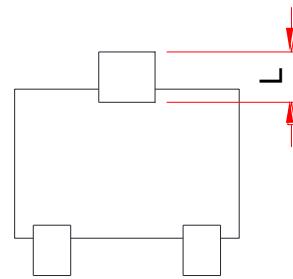
Top View



Side View

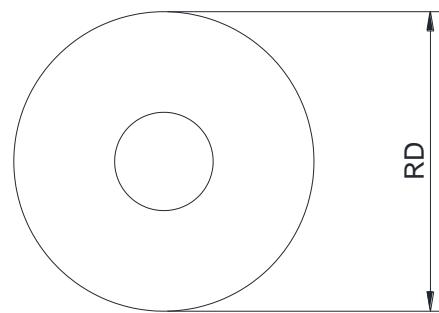
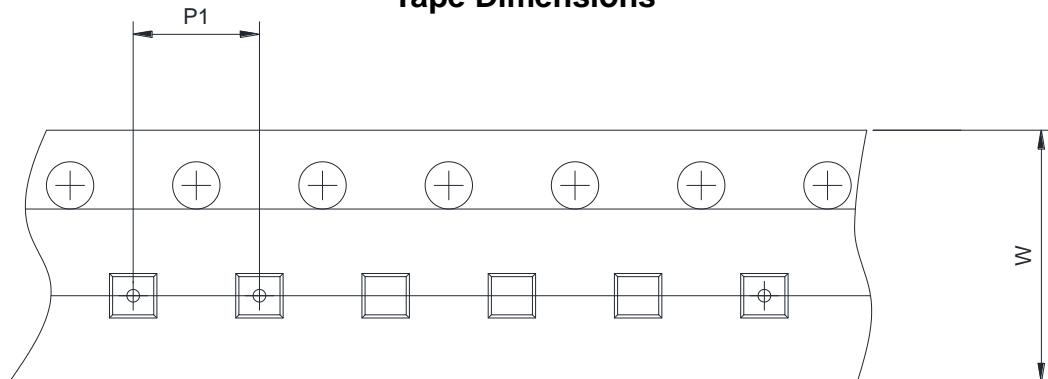
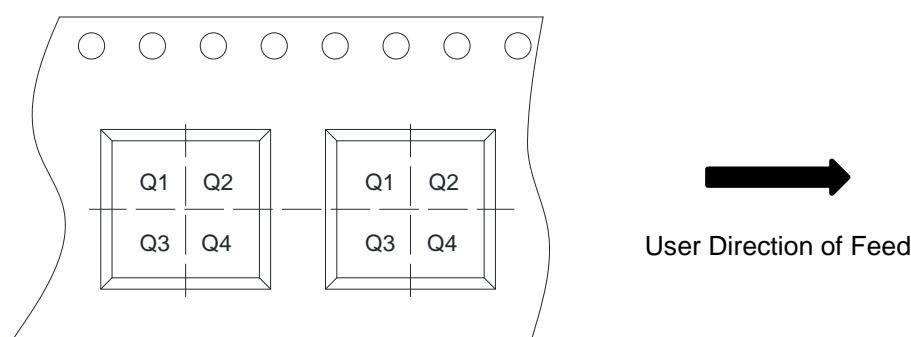


Side View



Bottom View

Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	0.43	-	0.55
A1	0.00	-	0.05
c	0.08	0.13	0.18
b1	0.27	-	0.37
b2	0.17	-	0.27
L	0.27 Ref.		
L1	0.15	0.20	0.25
D	1.15	1.20	1.25
E	1.15	1.20	1.25
E1	0.75	0.80	0.85
e	0.80 Typ.		
$\theta$	7 ° Ref.		

**TAPE AND REEL INFORMATION**
**Reel Dimensions**

**Tape Dimensions**

**Quadrant Assignments For PIN1 Orientation In Tape**


<b>RD</b>	<b>Reel Dimension</b>	<input checked="" type="checkbox"/> 7inch <input type="checkbox"/> 13inch
<b>W</b>	<b>Overall width of the carrier tape</b>	<input checked="" type="checkbox"/> 8mm <input type="checkbox"/> 12mm <input type="checkbox"/> 16mm
<b>P1</b>	<b>Pitch between successive cavity centers</b>	<input checked="" type="checkbox"/> 2mm <input type="checkbox"/> 4mm <input type="checkbox"/> 8mm
<b>Pin1</b>	<b>Pin1 Quadrant</b>	<input type="checkbox"/> Q1 <input type="checkbox"/> Q2 <input checked="" type="checkbox"/> Q3 <input type="checkbox"/> Q4